ASSOCIATION CONNECTIVE LECTRONICS INDUSTRIES® international and Pa	PC. Bannock	burn. Illinois. A	Il rights reserved untions.	under both le	his docume evel parts, t	ent is a declarat	ion of the su	ubstances s all lower	within the manufactu r level materials for w	rer listed	item. Note manufactur	if the item is an a er has engineering	ssembly with lower responsibility.	
52.21.1 IPC Web Site for Information on IPC-1752 Standard Form T				Form Type * Distribute	Class 6 - RoHS Yes/No, Homogeneous Materi					ials and N	als and Mfg Information			
Supplier Information														
Company name*	Company un	Company unique ID			Unique ID Authority					Response Date*				
onsemi										2024-0	2024-05-11			
Contact Name	ntact Name Title - Contact				Phone - Contact*				Email	Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
Authorized Representative*	Title - Repres	Title - Representative			Phone - Representative*				Email	Email - Representative*				
Product-Env-Stewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Iten	n Number	Number Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
	NSBC14 G	NSBC143ZPDXV6T1 SOT-563 COMPL G OH		LEMENTARY 4.7	7/47 K	2024-05-11 C		CN1		3.12	mg	Each		
Manufacturing Proccess Informa	tion													
Terminal Plating / Grid Array M	terial Terminal Base Alloy		J-STD-020 MSL F	Rating	Peak Proc	Process Body Temperature Max Time at Peak		Temperature Number of Reflow Cycles		cles				
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260 C		С	30		seconds 3			
Comments														
level 1 - maximum time at peak temperat	ure during so	Idering is 10-3	0 seconds											
For more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.1	mg	Supplier	Silicon (Si)	7440-21-3		0.1	mg	
Lead Frame	1.2	mg	В	Nickel (Ni)	7440-02-0		0.4512	mg	
			Supplier	Iron (Fe)	7439-89-6		0.6456	mg	
			Supplier	Copper (Cu)	7440-50-8		0.1032	mg	
Mold Compound-Black	1.73	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.173	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.0087	mg	
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.2508	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		1.1245	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.173	mg	
Plating	0.08	mg	Supplier	Tin (Sn)	7440-31-5		0.08	mg	
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg	